UNISONIC TECHNOLOGIES CO., LTD

7N50-TC Power MOSFET

7.0A, 500V N-CHANNEL POWER MOSFET

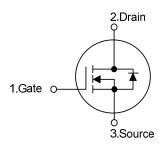
■ DESCRIPTION

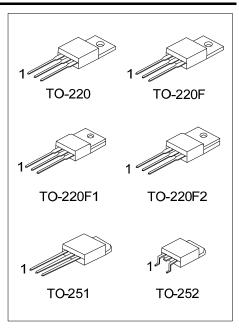
The UTC **7N50-TC** is a high voltage power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

■ FEATURES

- * $R_{DS(ON)} \le 1.15 \Omega$ @ $V_{GS}=10V$, $I_D=3.5A$
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness

■ SYMBOL

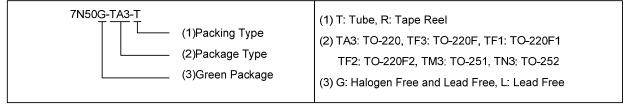




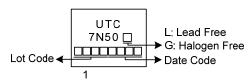
■ ORDERING INFORMATION

Ordering Number		Daakaga	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
7N50L-TA3-T	7N50G-TA3-T	TO-220	G	D	S	Tube	
7N50L-TF1-T	7N50G-TF1-T	TO-220F1	G	D	S	Tube	
7N50L-TF2-T	7N50G-TF2-T	TO-220F2	G	D	S	Tube	
7N50L-TF3-T	7N50G-TF3-T	TO-220F	G	D	S	Tube	
7N50L-TM3-T	7N50G-TM3-T	TO-251	G	D	S	Tube	
7N50L-TN3-R	7N50G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



■ MARKING



www.unisonic.com.tw 1 of 8

7N50-TC Power MOSFET

■ **ABSOLUTE MAXIMUM RATINGS** (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	500	V
Gate-Source Voltage		V_{GSS}	±30	V
Continuous Drain Current		I_{D}	7	Α
Pulsed Drain Current (Note 2)		I_{DM}	14	Α
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	245	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	5.3	V/ns
Power Dissipation	TO-220		120	W
	TO-220F/TO-220F1 TO-220F2	P_D	32	W
	TO-251/TO-252		58	W
Junction Temperature		ΤJ	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 10mH, I_{AS} = 7.0A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25°C
- 4. $I_{SD} \le 4.0 \text{A}$, di/dt $\le 200 \text{A}/\mu \text{s}$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL RATING		UNIT	
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-220F2	θ_{JA}	62.5	°C/W	
	TO-251/TO-252		110	°C/W	
Junction to Case	TO-220		1.04	°C/W	
	TO-220F/TO-220F1 TO-220F2	θυς	3.9	°C/W	
	TO-251/TO-252		2.15 (Note)	°C/W	

Note: The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

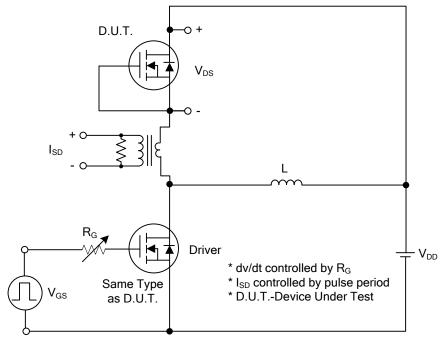
■ **ELECTRICAL CHARACTERISTICS** (T_J =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	500			V
Drain-Source Leakage Current		I_{DSS}	$V_{DS} = 500V, V_{GS} = 0V$			10	μΑ
Gate- Source Leakage Current	Forward	I _{GSS}	$V_{GS} = 30V, V_{DS} = 0V$			100	nA
	Reverse		$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}$, $I_D = 250\mu A$			4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	$V_{GS} = 10V, I_D = 3.5A$			1.15	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance	Input Capacitance				641		pF
Output Capacitance		Coss	V_{DS} =25V, V_{GS} =0V, f=1.0 MHz		85		pF
Reverse Transfer Capacitance		C_{RSS}			5		рF
SWITCHING CHARACTERISTICS	S						
Total Gate Charge (Note 1)		Q_{G}	V _{DS} =100V, V _{GS} =10V, I _D =7A,		20		nC
Gate-Source Charge		Q_GS	$I_D=1$ mA (Note 1, 2)		7		nC
Gate-Drain Charge		Q_GD	ID- IIIA (Note 1, 2)		2.7		nC
Turn-On Delay Time (Note 1)		$t_{D(ON)}$			32		ns
Turn-On Rise Time		t _R	V_{DD} =100V, V_{GS} =10V, I_{D} =5A,		24		ns
Turn-Off Delay Time		$t_{D(OFF)}$	$R_G = 25\Omega$ (Note 1, 2)		47		ns
Turn-Off Fall Time		t _F			39		ns
DRAIN-SOURCE DIODE CHARA	CTERISTIC	S AND MAXII	MUM RATINGS				
Maximum Body-Diode Continuous Current		Is				7	Α
Maximum Body-Diode Pulsed Current		I _{SM}				14	Α
Drain-Source Diode Forward Voltage		V_{SD}	I _S =7.0A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time		t _{rr}	I _S =7.0A, V _{GS} =0V,		340		nS
Body Diode Reverse Recovery Charge		Q_{rr}	di/dt=100A/μs		4.5		μC

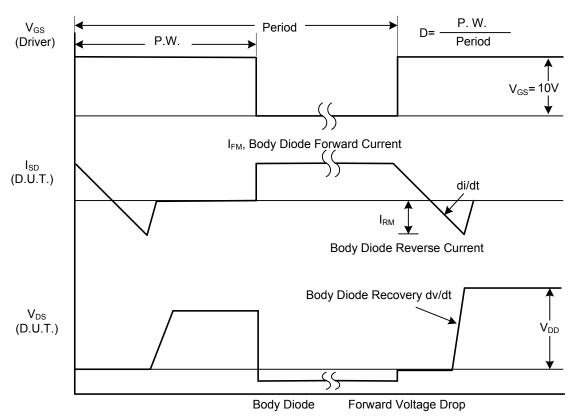
Notes: 1. Pulse Test: Pulse width \leq 300 μ s, Duty cycle \leq 2%.

^{2.} Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS



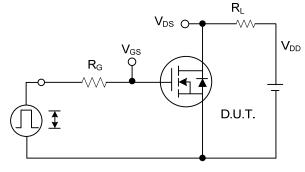
Peak Diode Recovery dv/dt Test Circuit



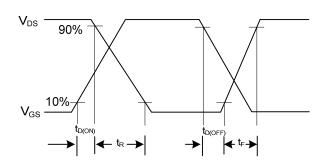
Peak Diode Recovery dv/dt Waveforms

7N50-TC Power MOSFET

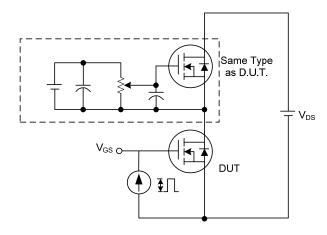
■ TEST CIRCUITS AND WAVEFORMS



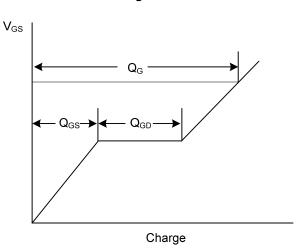
Switching Test Circuit



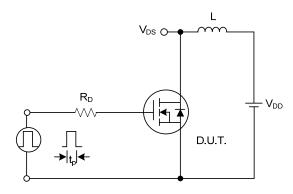
Switching Waveforms



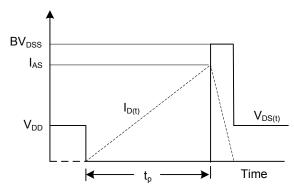
Gate Charge Test Circuit



Gate Charge Waveform

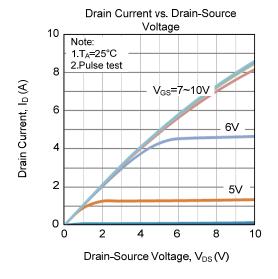


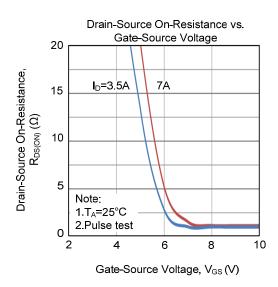
Unclamped Inductive Switching Test Circuit

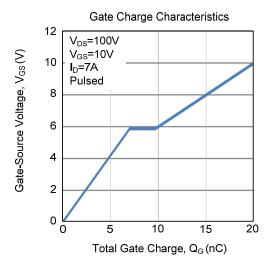


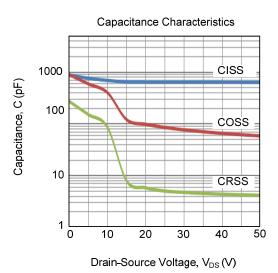
Unclamped Inductive Switching Waveforms

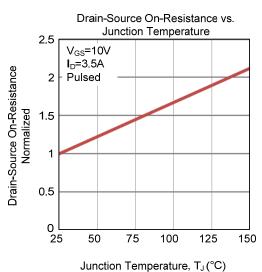
■ TYPICAL CHARACTERISTICS

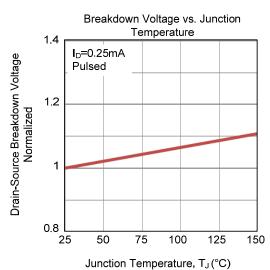




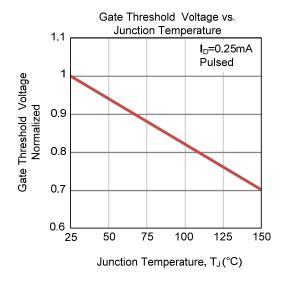


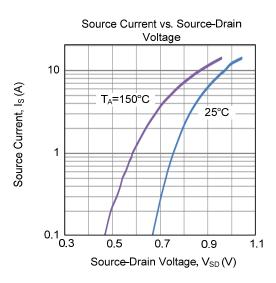


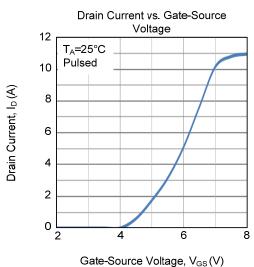


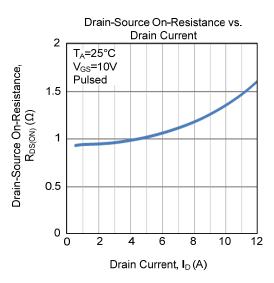


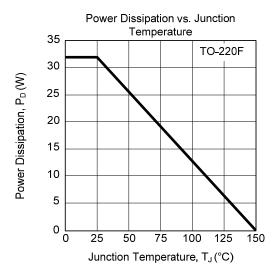
■ TYPICAL CHARACTERISTICS (Cont.)

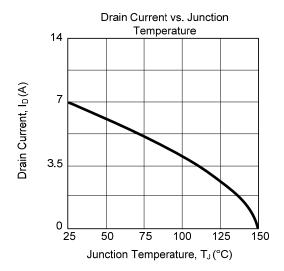






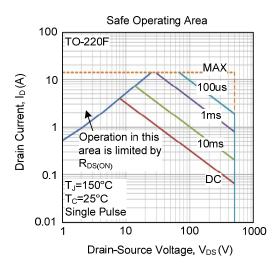


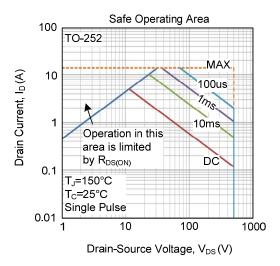




7N50-TC Power MOSFET

■ TYPICAL CHARACTERISTICS (Cont.)





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